TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

## GT40Q323

## Voltage Resonance Inverter Switching Application

• Enhancement-mode

- High speed:  $t_f = 0.14 \mu s$  (typ.) (IC = 40A)
- FRD included between emitter and collector
- 4th generation
- TO-3P (N) (Toshiba package name)

## **Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Collector-emitter voltage		V <sub>CES</sub>	1200	V	
Gate-emitter voltage		V <sub>GES</sub>	±25	V	
Continuous collector current	@ Tc = 100°C	la.	20	A	
	@ Tc = 25°C	IC	39		
Pulsed collector current		I <sub>CP</sub>	80	Α	
Diode forward current	DC	IF	10	А	
	Pulsed	I <sub>FP</sub>	80		
Collector power dissipation	@ Tc = 100°C	Pc	80	W	
	@ Tc = 25°C	FC	200		
Junction temperature		Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 150	°C	

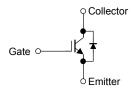
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Weight: 4.6 g (typ.)

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance (IGBT)	R <sub>th (j-c)</sub>	0.625	°C/W
Thermal resistance (diode)	R <sub>th (j-c)</sub>	1.79	°C/W

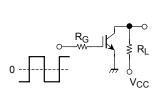
## **Equivalent Circuit**

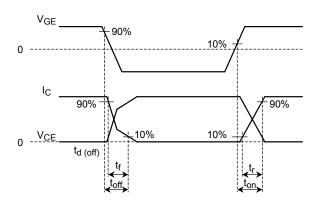


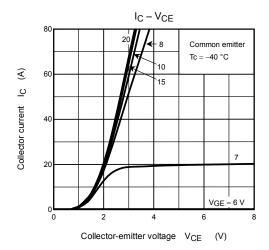
## Electrical Characteristics (Ta = 25°C)

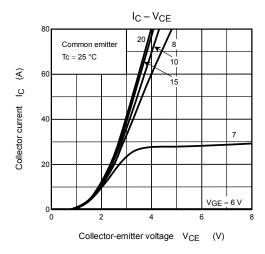
Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GES</sub>	V <sub>GE</sub> = ±25 V, V <sub>CE</sub> = 0	_	_	±500	nA
Collector cut-off current		I <sub>CES</sub>	V <sub>CE</sub> = 1200 V, V <sub>GE</sub> = 0	_	_	5.0	mA
Gate-emitter cut-	off voltage	V <sub>GE</sub> (OFF)	I <sub>C</sub> = 40 mA, V <sub>CE</sub> = 5 V	4.0	_	7.0	V
Collector-emitter	saturation voltage	V <sub>CE (sat)</sub>	I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	_	3.0	3.7	V
Input capacitance		C <sub>ies</sub>	V <sub>CE</sub> = 10 V, V <sub>GE</sub> = 0, f = 1 MHz	_	5550	_	pF
Switching time	Rise time	t <sub>r</sub>	Resistive Load	_	0.18	_	- µs
	Turn-on time	t <sub>on</sub>	V <sub>CC</sub> = 600 V, I <sub>C</sub> = 40 A	_	0.26	_	
	Fall time	t <sub>f</sub>	$V_{GG}$ = ±15 V, $R_{G}$ = 39 $\Omega$	_	0.14	0.21	
	Turn-off time	t <sub>off</sub>	(Note 1)	_	0.43	_	
Diode forward vo	ode forward voltage V <sub>F</sub>		I <sub>F</sub> = 10 A, V <sub>GE</sub> = 0	_	_	2.1	V
Reverse recovery time t <sub>rr</sub>		t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = −20 A/µs	_	0.4	_	μs

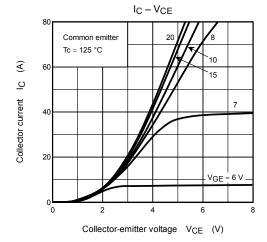
Note 1: Switching time measurement circuit and input/output waveforms

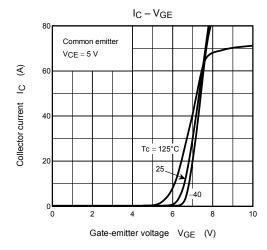


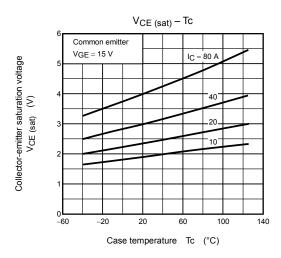




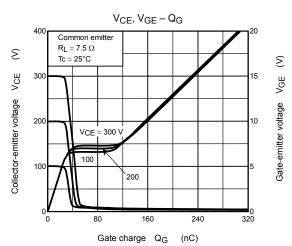


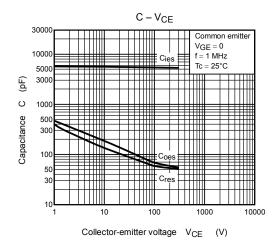


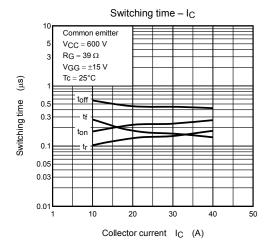


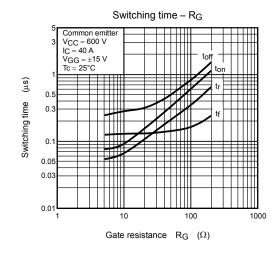


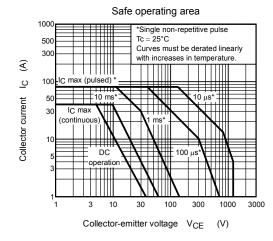
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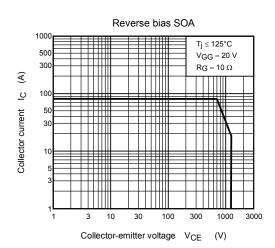


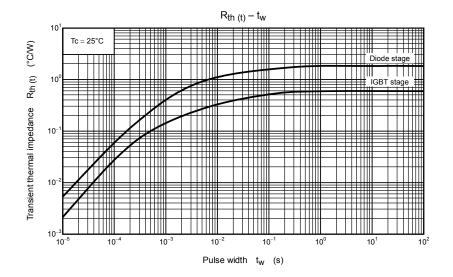


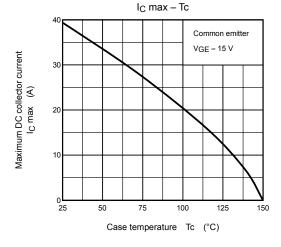


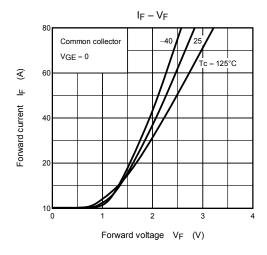


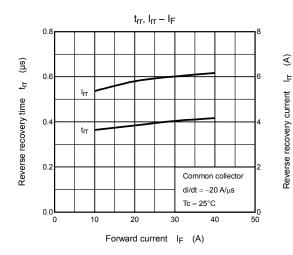


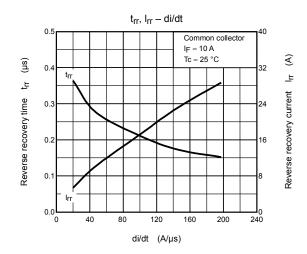












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